TOSHIBA

MICROWAVE SEMICONDUCTOR TECHNICAL DATA

MICROWAVE POWER MMIC AMPLIFIER TMD0608-4

FEATURES

- HIGH POWER
 P1dB=36.0dBm at 5.65GHz to 8.50GHz
- HIGH GAIN
 G1dB=28.0dB at 5.65GHz to 8.50GHz
- BROAD BAND INTERNALLY MATCHED
- HERMETICALLY SEALED PACKAGE

ABSOLUTE MAXIMUM RATINGS (Ta= 25°C)

CHARACTERISTICS	SYMBOL	UNIT	RATING
Drain Supply Voltage	VDD	V	15
Gate Supply Voltage	VGG	V	-5
Input Power	Pin	dBm	18
Flange Temperature	Tc	°C	-30 to +80
Storage Temperature	Tstg	°C	-65 to +175

RF PERFORMANCE SPECIFICATIONS (Ta= 25°C)

CHARACTERISTICS	SYMBOL	CONDITIONS	UNIT	MIN.	TYP.	MAX.
Output Power at 1dB Gain	P1dB		dBm	34.5	36.0	
Compression Point		VDD= 10V				
Power Gain at 1dB Gain	G1dB	IDDset= 1.9A	dB	25.0	28.0	
Compression Point						
Drain Current	IDD	f = 5.65 to 8.50GHz	Α		2.6	3.0
3 rd Order Intermodulation	IM3	Two-tone test	dBc	-37	-40	
Distortion		Po=25.5dBm				
		(single carrier level)				

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PACKAGE OUTLINE (7-BA25A)

